CRYSTAL

Crystal Group FG2 1100 Series: 10 servers



Transform the tactical edge with real-time processing

The Crystal Group FG2 1100 Series servers provide enhanced storage and CPU options based on specific application needs.

Intel's® 3rd Gen Xeon® Scalable processors have built-in artificial intelligence (AI) acceleration with Intel® Deep Learning Boost, advanced encryption standard (AES), total memory encryption, software guard extensions (SGX), support a single- or dual-socket P+FG2 motherboard, and increase system memory bandwidth with up to eight 3200MHz DDR4 channels.

The Epyc 7003 series platform with AMD 3D V-Cache™ features up to 24 cores, 48 threads and 160 PCle Gen4 lanes in a dual-socket board. This resource-saving architecture boasts up to 4TB of ECC DDR4 RAM, delivering the highest performance available for compute- and memory-intensive workloads while lowering power consumption.

This NVIDIA-Certified System is validated for optimal performance, manageability, security and scalability.

Use cases

- Battlespace management and visualization
- C4/ISR processing
- High-density computing in air, on land or at sea
- Sensor fusion for pinpoint situational awareness
- Cryptographic engines

Tested to MIL-STD-810







compatibility

Electromagnetic

GPU server



· Inference at scale at the tactical edge

instant data destruction



· Security applications requiring tamper resistance and



Humidity

Shock

Vibration

Sand/Dust



crystalrugged.com

Crystal Group FG2 1100 Series technical specifications

Mechanical	Height: 1.75" (4.45 cm) Width: 16.9" (44.5 cm) Depth: 19" (48.3 cm) or 22" (55.9 cm) Weight: 23-26 lbs (10.4-11.8 kg) or 26-29 lbs (11.8-13.2 kg)
Mounting	Glides, fixed mount (front and rear), or Jonathan rails
Power Supply	800WAC, 50/60 or 400Hz, 505W 18-36VDC, 1+1 600W DC
CPU Architecture	Gen3 Intel Xeon Scalable or AMD EPYC 7003 series processors
	CPU Power: up to 165W per socket
Memory	16GB-4TB DDR4 ECC RDIMM/LRDIMM (motherboard dependent)
Expansion	One low-profile or full-height PCIe slot (motherboard dependent)
External Bays	Option 1: Up to four bays populated with FORCE module accessories Option 2: Optical drive with up to two bays populated with FORCE module accessories
Software Compatibility	Windows 10, Windows Server, VMware, Linux, RedHat
	Environmental testing standards
MIL-STD-810: Environmental Engineering Considerations and Laboratory Tests	Method 500, Altitude: 12,500 ft. operation, 40,000 ft. transport ² Method 501, Operational Temperature, high: Procedure II: +55°C, two-hour dwell, four cycles ¹ Method 502, Operational Temperature, low: Procedure II: -40°C, two-hour dwell, four cycles ¹ Method 503, Thermal Shock: Procedure II: 10 cycles, -40°C to +55°C, 15-min dwell, <1-min transfer time ² Method 507, Humidity: Procedure II: 240 hours <i>with optional conformal coating kit</i> ¹ Method 508, Fungus: 28 days, mixed spore, 30°C 95% RH ² Method 509, Salt fog: 48-hour test ² Method 510, Sand-Dust: Procedure I: Blasting dust, 12 hours ² Method 513, Acceleration: Procedure II: 9g ² Method 514, Vibration: Procedure II: 4.7G, 5-2,000Hz, 60 min/axis, 3 axis ¹ Method 516, Shock: Procedures I & V: 40G, 11ms, 18 pulses, 3/axis both directions ¹
MIL-STD-1474E	Acoustic Noise, Requirement S, Grade A3 ²
MIL-STD-167-1A	Ship Vibration, Type 11
MIL-S-901E	Shipboard Shock, Class II, A/B ²
	Electromagnetic compatibility standards
MIL-STD-461	EMI/EMC, RE102, CE102; surface ship, below deck, and ground ¹

Different options for different needs

The FG2 product family also includes the 2600 2U Series and 3700 3U Series servers to accommodate different edge computing needs. **Contact us** to determine the best FG2 solution to achieve your edge computing and Al objectives.

In-house test reports provided for baseline units; customer-specific test options available upon request.

1: Test report available

2: Testing in progress

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